# MB05F THRU MB10F

MINIATURE GLASS PASSIVATED SINGLE-PHASE SURFACE MOUNT BRIDGE RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 0.5 AMPERE

#### **FEATURES**

· Surge overload rating: 30 amperes peak

· Ideal for printed circuit board

Plastic material has Underwriters Laboratory
Flammability Classification 94V-0

· Low leakage

· Reliable low cost construction utilizing molded

### **MECHANICAL DATA**

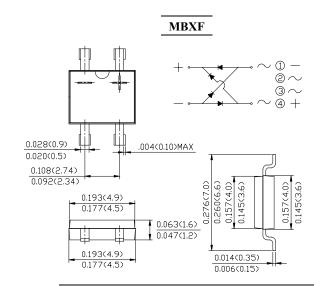
Case: Molded plastic, MBXF

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any

Weight: 0.00528ounce, 0.134gram



**Dimensions in inches and (millimeters)** 

### Maximum Ratings and Electrical Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

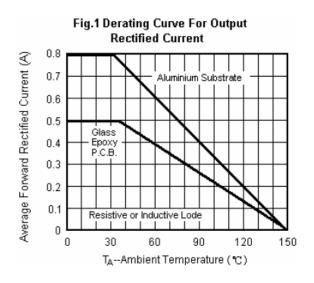
	Symbols	MB05F	MB1F	MB2F	MB4F	MB6F	MB8F	MB10F	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current				•	•	•		•	
(see Fig. 1) on glass-epoxy P.C.B (Note 2)	I <sub>(AV)</sub> 0.5 0.8							Amp	
on aluminum substrate (Note 3)									
Peak Forward Surge Current,									
8.3ms single half-sine-wave	$I_{\text{FSM}}$ 30						Amp		
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage	V	1.0							Volts
at 0.4A DC and 25 ℃	$V_{\rm F}$								
Maximum Reverse Current at T <sub>A</sub> =25℃	T	5.0 500							uAmp
at Rated DC Blocking Voltage T <sub>A</sub> =125°C	$I_R$								
Typical Junction Capacitance (Note 1)	$C_{J}$	13							pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$	60							°C/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	16							°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , Tstg				-55 to +15	0			ဗ

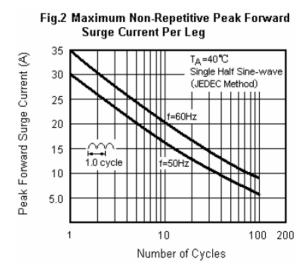
#### **NOTES:**

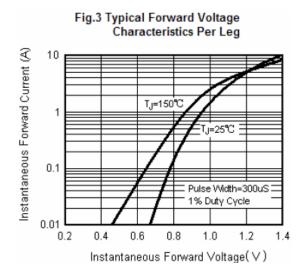
- 1- Measured at 1  $\mbox{MH}_{\mbox{\scriptsize Z}}$  and applied reverse voltage of 4.0 VDC.
- 2- On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads
- 3- On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad



## Characteristic Curves (TA=25 °C unless otherwise noted)







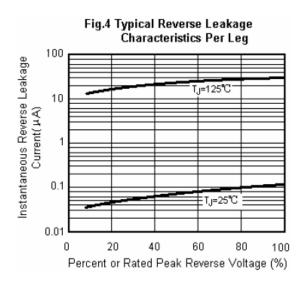


Fig.5 Typical Junction Capacitance Per Leg 30 Junction Capacitance (pF) TJ=25℃ f=1.0MHz 25 Vsig=50mVp-p 20 15 10 5.0 0 0.1 10 100 200 Reverse Voltage (v)